

6 Lake Street, Lawrence, MA 01841 1-800-446-1158 / (978) 620-2600 / Fax: (978) 689-0803

Website: http://www.microsemi.com

ELECTRICAL CHARACTERISTICS ($T_A = +25$ °C, unless otherwise noted)

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
ON CHARACTERISTICS (2)					
Forward-Current Transfer Ratio					
$I_C = 0.1 \text{mAdc}, V_{CE} = 10 \text{Vdc}$	2N2221A, L, UA, UB, UBC 2N2222A, L, UA, UB, UBC		30 50		
$I_{C} = 1.0 \text{mAdc}, V_{CE} = 10 \text{Vdc}$	2N2221A, L, UA, UB, UBC 2N2222A, L, UA, UB, UBC		35 75	150 325	
$I_C = 10$ mAdc, $V_{CE} = 10$ Vdc	2N2221A, L, UA, UB, UBC 2N2222A, L, UA, UB, UBC	$h_{ m FE}$	40 100		
$I_C = 150$ mAdc, $V_{CE} = 10$ Vdc	2N2221A, L, UA, UB, UBC 2N2222A, L, UA, UB, UBC		40 100	120 300	
$I_C = 500$ mAdc, $V_{CE} = 10$ Vdc	2N2221A, L, UA, UB, UBC 2N2222A, L, UA, UB, UBC		20 30		
Collector-Emitter Saturation Voltage					
$\begin{split} I_{C} &= 150 \text{mAdc}, I_{B} = 15 \text{mAdc} \\ I_{C} &= 500 \text{mAdc}, I_{B} = 50 \text{mAdc} \end{split}$		V _{CE(sat)}		0.3 1.0	Vdc
$\label{eq:Base-Emitter Voltage} Base-Emitter Voltage \\ I_C = 150 \text{mAdc}, I_B = 15 \text{mAdc} \\ I_C = 500 \text{mAdc}, I_B = 50 \text{mAdc} \\$		V _{BE(sat)}	0.6	1.2 2.0	Vdc

DYNAMIC CHARACTERISTICS

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Small-Signal Short-Circuit Forward Current Tra					
$I_C = 1.0 \text{mAdc}, V_{CE} = 10 \text{Vdc}, f = 1.0 \text{kHz}$	2N2221A, L, UA, UB, UBC 2N2222A, L, UA, UB, UBC	h_{fe}	30 50		
Magnitude of Small–Signal Short-Circuit Forward Current Transfer Ratio $I_{C}=20 mAdc,V_{CE}=20 Vdc,f=100 MHz$		h _{fe}	2.5		
Output Capacitance $V_{CB} = 10 V dc, I_E = 0, 100 kHz \leq f \leq 1.0 MHz$		$C_{ m obo}$		8.0	pF
Input Capacitance $V_{EB} = 0.5 V dc, \ I_C = 0, \ 100 kHz \le f \le 1.0 MHz$		C_{ibo}		25	pF

SWITCHING CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On Time See figure 8 of MIL-PRF-19500/255	t _{on}		35	ηs
Turn-Off Time See Figure 9 of MIL-PRF-19500/255	$t_{ m off}$		300	ηs

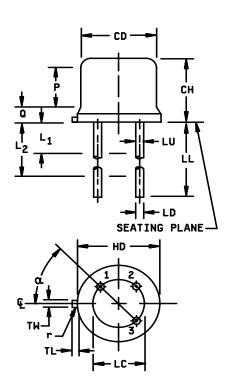
(2) Pulse Test: Pulse Width = $300\mu s$, Duty Cycle $\leq 2.0\%$.

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PACKAGE DIMENSIONS



NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Beyond r (radius) maximum, TL shall be held for a minimum length of .011 inch (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- 6. Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC.
- Dimension LU applies between L₁ and L₂. Dimension LD applies between L₂ and LL minimum. Diameter is uncontrolled in L₁ and beyond LL minimum.
- 8. All three leads.
- 9. The collector shall be internally connected to the case.
- 10. Dimension r (radius) applies to both inside corners of tab.
- 11. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.
- 12. Lead 1 = emitter, lead 2 = base, lead 3 = collector.
- 13. For L suffix devices, dimension LL = 1.5 inches (38.10 mm) min. and 1.75 inches (44.45 mm) max.

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		Dimensions				
Symbol	Inc	hes	Millir	neters	Note	
	Min	Max	Min	Max		
CD	.178	.195	4.52	4.95		
CH	.170	.210	4.32	5.33		
HD	.209	.230	5.31	5.84		
LC	.100) TP	2.54	I TP	6	
LD	.016	.021	0.41	0.53	7,8	
LL	.500	.750	12.70	19.05	7,8,13	
LU	.016	.019	0.41	0.48	7,8	
L_1		.050		1.27	7,8	
L_2	.250		6.35		7,8	
P	.100		2.54			
Q		.030		0.76	5	
TL	.028	.048	0.71	1.22	3,4	
TW	.036	.046	0.91	1.17	3	
r		.010		0.25	10	
α	45°	TP	P 45° TP		6	
	1	1, 2, 9, 11	, 12, 13			

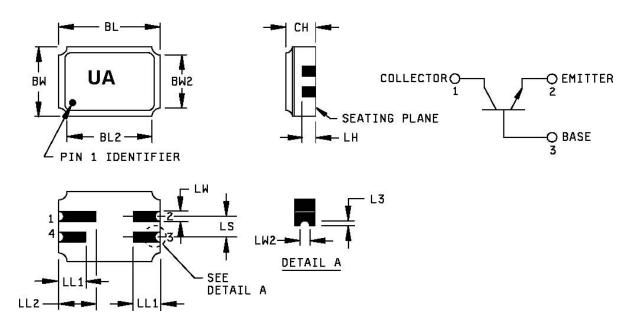
FIGURE 1. Physical dimensions (similar to TO-18).

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NOTES:

- 1. Dimensions are in inches.
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- 3. Dimension CH controls the overall package thickness. When a window lid is used, dimension CH must increase by a minimum of .010 inch (0.254 mm) and a maximum of .040 inch (1.020 mm).
- 4. The corner shape (square, notch, radius) may vary at the manufacturer's option, from that shown on the drawing.
- 5. Dimensions LW2 minimum and L3 minimum and the appropriate castellation length define an unobstructed three-dimensional space traversing all of the ceramic layers in which a castellation was designed. (Castellations are required on the bottom two layers, optional on the top ceramic layer.) Dimension LW2 maximum and L3 maximum define the maximum width and depth of the castellation at any point on its surface. Measurement of these dimensions may be made prior to solder dipping.
- 6. The co-planarity deviation of all terminal contact points, as defined by the device seating plane, shall not exceed .006 inch (0.15mm) for solder dipped leadless chip carriers.
- 7. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

Symbol	Inches		Millimeters		Note
	Min	Max	Min	Max	
BL	.215	.225	5.46	5.71	
BL2		.225		5.71	
BW	.145	.155	3.68	3.93	
BW2		.155		3.93	
CH	.061	.075	1.55	1.90	3
L3	.003	.007	0.08	0.18	5
LH	.029	.042	0.74	1.07	
LL1	.032	.048	0.81	1.22	
LL2	.072	.088	1.83	2.23	
LS	.045	.055	1.14	1.39	
LW	.022	.028	0.56	0.71	
LW2	.006	.022	0.15	0.56	5

Pin no.	1	2	3	4
Transistor	Collector	Emitter	Base	N/C

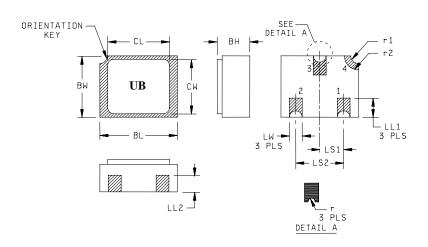
FIGURE 2. Physical dimensions, surface mount (UA version).

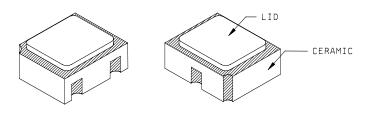
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	Dimensions				
Symbol	Inc	Inches Millimeters		Note	
	Min	Max	Min	Max	
BH	.046	.056	1.17	1.42	
BL	.115	.128	2.92	3.25	
BW	.085	.108	2.16	2.74	
CL		.128		3.25	
CW		.108		2.74	
LL1	.022	.038	0.56	0.96	
LL2	.017	.035	0.43	0.89	

Dimensions					
Symbol	Inches		Millimeters		Note
	Min	Max	Min	Max	
LS_1	.036	.040	0.91	1.02	
LS_2	.071	.079	1.81	2.01	
LW	.016	.024	0.41	0.61	
r		.008		.203	
\mathbf{r}_1		.012		.305	
\mathbf{r}_2		.022		.559	

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Hatched areas on package denote metalized areas.
- 4. Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

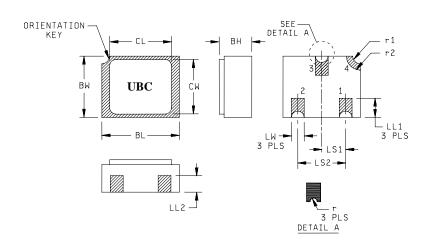
FIGURE 3. Physical dimensions, surface mount (UB version)

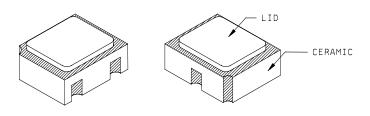
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	Dimensions					
Symbol	Inc	nches Millimeters		Inches		Note
	Min	Max	Min	Max		
BH	.046	.071	1.17	1.80		
BL	.115	.128	2.92	3.25		
BW	.085	.108	2.16	2.74		
CL		.128		3.25		
CW		.108		2.74		
LL1	.022	.038	0.56	0.96		
LL2	.017	.035	0.43	0.89		

Dimensions					
Symbol	Inches		Millimeters		Note
	Min	Max	Min	Max	
LS_1	.036	.040	0.91	1.02	
LS_2	.071	.079	1.81	2.01	
LW	.016	.024	0.41	0.61	
r		.008		.203	
\mathbf{r}_1		.012		.305	
\mathbf{r}_2		.022		.559	

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Hatched areas on package denote metalized areas.
- 4. Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Connected to the lid braze ring.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

FIGURE 4. Physical dimensions, surface mount (UBC version, ceramic lid)

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